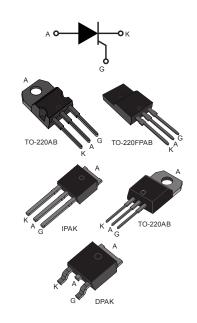


## Sensitive and standard 8 A SCRs



# Product status link

TN805, TN815, TS820, TYN608

#### **Features**

- On-state rms current, I<sub>T(RMS)</sub> 8 A
- Repetitive peak off-state voltage, V<sub>DRM</sub>/V<sub>RRM</sub> 600 and 800 V
- Triggering gate current, I<sub>GT</sub> 0.2 to 15 mA

#### **Description**

Available either in sensitive (TS8) or standard (TN8 / TYN) gate triggering levels, the 8 A SCR series is suitable to fit all modes of control found in applications such as overvoltage crowbar protection, motor control circuits in power tools and kitchen aids, inrush current limiting circuits, capacitive discharge ignition and voltage regulation circuits.

Available in through-hole or surface-mount packages, they provide an optimized performance in a limited space.

Product summary						
Order code	Voltage (x00) V <sub>DRM</sub> /V <sub>RRM</sub>		Sensitivity I <sub>GT</sub>	Package		
	600 V	800 V	-61			
TS820-600B	X		0.2 mA	DPAK		
TS820-600H	X		0.2 mA	IPAK		
TS820-600T	X		0.2 mA	TO-220AB		
TS820-600FP	X		0.2 mA	TO-220FPAB		
TN805-600B	X		5 mA	DPAK		
TN815-x00B	X	X	15 mA	DPAK		
TN815-800H		X	15 mA	IPAK		
TYN608RG	X		15 mA	TO-220AB		



## 1 Characteristics

Table 1. Absolute ratings (limiting values)

				Va	lue	
Symbol	Par	TN805   TN815   TYN608   TS820		Unit		
I	RMS on-state current On-state rms cur	rrent	T <sub>C</sub> = 110 °C		0	_
I <sub>T(RMS)</sub>	(180° conduction angle)		TO-220FPAB, T <sub>C</sub> = 91 °C		8	Α
	A	#:	T <sub>C</sub> = 110 °C		-	
I <sub>T(AV)</sub> Average on-state current (180° conduc		ction angle)	TO-220FPAB, T <sub>C</sub> = 91 °C	5		Α
	Non repetitive surge peak on-state	t <sub>p</sub> = 8.3 ms	T - 05 °C	73	100	_
I <sub>TSM</sub>	current	t <sub>p</sub> = 10 ms	T <sub>j</sub> = 25 °C	70	95	Α
l <sup>2</sup> t	I <sup>2</sup> t value for fusing	t <sub>p</sub> = 10 ms	T <sub>j</sub> = 25 °C	24.5	45	A <sup>2</sup> s
dl/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \le 100 \text{ ns}$ $F = 60 \text{ Hz}$		T <sub>j</sub> = 125 °C	50		A/µs
I <sub>GM</sub>	Peak gate current	t <sub>p</sub> = 20 μs	T <sub>j</sub> = 125 °C		4	Α
P <sub>G(AV)</sub>	Average gate power dissipation $T_j = 125 \text{ °C}$				1	W
T <sub>stg</sub>	Storage junction temperature range			-40 to +150		°C
Tj	Operating junction temperature range -40 to +125					°C
$V_{RGM}$	Maximum peak reverse gate voltage (f	or TN8x5 and	ΓΥN608 only)		5	V

Table 2. Sensitive electrical characteristics ( $T_j$  = 25 °C, unless otherwise specified)

Symbol	Parameter			TS820	Unit
I <sub>GT</sub>	$V_{D} = 12 \text{ V}, \text{ R}_{I} = 140 \Omega$	V = 40 V D = 440 O		200	μA
V <sub>GT</sub>	VD = 12 V, IV = 140 22		Max.	0.8	V
$V_{RG}$	I <sub>RG</sub> = 10 μA		Min.	8	V
$V_{GD}$	$V_D = V_{DRM}$ , $R_L = 3.3 \text{ k}\Omega$ , $R_{GK} = 220 \Omega$	T <sub>j</sub> = 125 °C	Min.	0.1	V
I <sub>H</sub>	$I_T = 50 \text{ mA}, R_{GK} = 1 \text{ k}\Omega$		Max.	5	mA
IL	$I_G = 1$ mA, $R_{GK} = 1$ k $\Omega$		Max.	6	mA
dV/dt	$V_D = 65\% V_{DRM}, R_{GK} = 220 \Omega$	T <sub>j</sub> = 125 °C	Min.	5	V/µs
V <sub>TM</sub>	I <sub>TM</sub> = 16 A, t <sub>p</sub> = 380 μs	T <sub>j</sub> = 25 °C	Max.	1.6	V
V <sub>t0</sub>	Threshold voltage	T <sub>j</sub> = 125 °C	Max.	0.85	V
R <sub>d</sub>	Dynamic resistance $T_j$ = 125 °C		Max.	46	mΩ
I <sub>DRM</sub>	$V_{DRM} = V_{RRM}, R_{GK} = 220 \Omega$	T <sub>j</sub> = 25 °C	Max.	5	μΑ
I <sub>RRM</sub>	VDRM = VRRM, NGK = 220 12	T <sub>j</sub> = 125 °C	ividX.	1	mA

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Table 3. Standard electrical characteristics ( $T_j$  = 25 °C, unless otherwise specified)

Symbol	Parameter			TN805	TN815	TYN608	Unit
la-			Min.	0.5	2	2	mA
I <sub>GT</sub>	$V_D = 12 \text{ V}, R_L = 140 \Omega$		Max.	5	15	15	IIIA
V <sub>GT</sub>			Max.		1.3		V
$V_{GD}$	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$	T <sub>j</sub> = 125 °C	Min.		0.2		V
I <sub>H</sub>	I <sub>T</sub> = 100 mA, gate open		Max.	25	40	30	mA
IL	I <sub>G</sub> = 1.2 I <sub>GT</sub>		Max.	30	50	70	mA
dV/dt	V <sub>D</sub> = 67% V <sub>DRM</sub> , gate open	T <sub>j</sub> = 125 °C	Min.	50	150	150	V/µs
V <sub>TM</sub>	I <sub>TM</sub> = 16 A, t <sub>p</sub> = 380 μs	T <sub>j</sub> = 25 °C	Max.	1.6			V
V <sub>t0</sub>	Threshold voltage	T <sub>j</sub> = 125 °C	Max.	0.85			V
R <sub>d</sub>	Dynamic resistance $T_j = 1$		Max.	46			mΩ
I <sub>DRM</sub>	V -V	T <sub>j</sub> = 25 °C			5		
I <sub>RRM</sub>	$V_{DRM} = V_{RRM}$	T <sub>j</sub> = 125 °C	Max.	2			mA

Table 4. Thermal resistance (maximum values)

Symbol	Parameter	Parameter				
R <sub>th(j-c)</sub>	(j-c) Junction to case (DC)		IPAK / DPAK / TO-220AB	1.3	°C/W	
				4.6		
	Junction to ambient	$S^{(1)} = 0.5 \text{ cm}^2$	DPAK	70		
R <sub>th(j-a)</sub>	Junction to ambient		TO-220AB / TO-220FPAB	60	°C/W	
			IPAK	100		

1. S = Copper surface under tab



#### 1.1 **Characteristics curves**

Figure 1. Maximum average power dissipation versus average on-state current

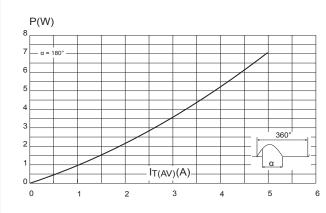


Figure 2. Average and DC on-state current versus case temperature

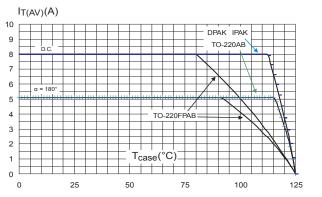
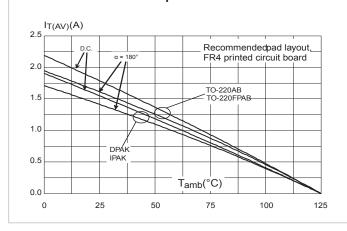


Figure 3. Average and DC on-state current versus ambient | Figure 4. Relative variation of thermal impedance junction temperature



to case versus pulse duration

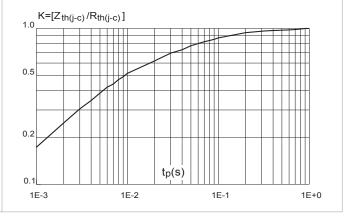


Figure 5. Relative variation of thermal impedance junction to ambient versus pulse duration

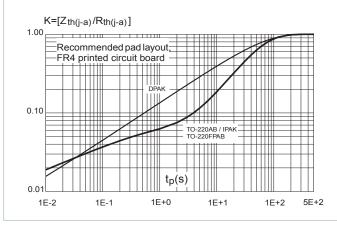
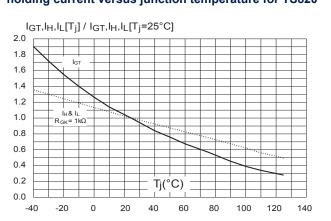


Figure 6. Relative variation of gate trigger current and holding current versus junction temperature for TS820



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Figure 7. Relative variation of gate trigger current and holding current versus junction temperature

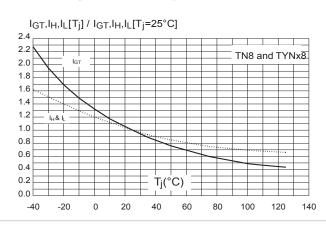


Figure 8. Relative variation of holding current versus gate-cathode resistance (typical values)

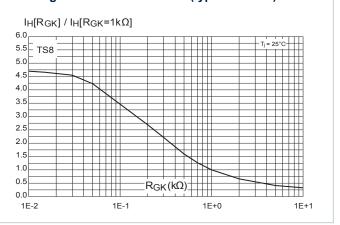


Figure 9. Relative variation of dV/dt immunity versus gatecathode resistance (typical values) for TS820

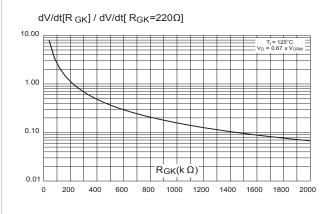


Figure 10. Relative variation of dV/dt immunity versus gate-cathode capacitance (typical values) for TS820

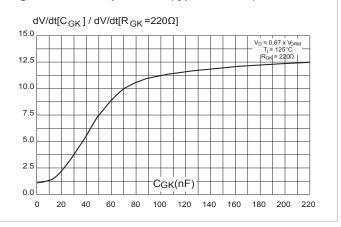


Figure 11. Surge peak on-state current versus number of cycles

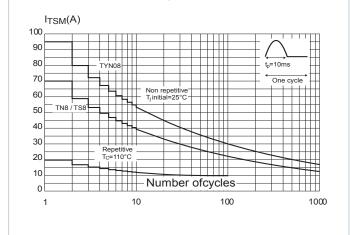
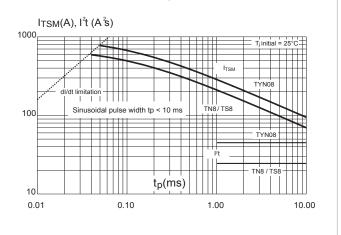


Figure 12. Non-repetitive surge peak on-state current and corresponding values of l2t



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Figure 13. On-state characteristics (maximum values)

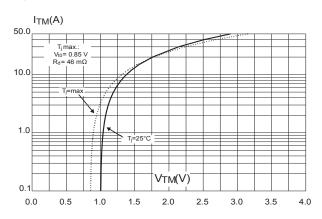
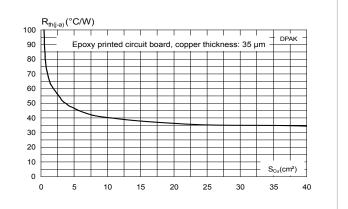


Figure 14. Thermal resistance junction to ambient versus copper surface under tab



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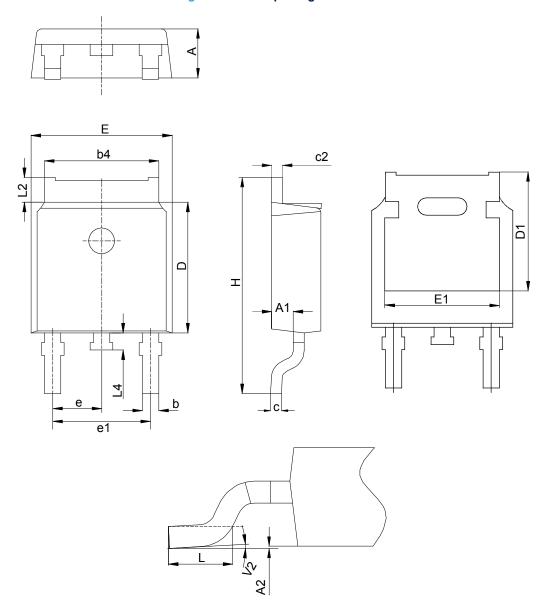
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

#### 2.1 DPAK package information

- Molding compouned resin is halogen free and meets UL94 flammability standard, level V0
- · Lead-free package leads plating

Figure 15. DPAK package outline



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**Dimensions** Ref. **Millimeters** Inches(1) Min. Min. Тур. Max. Тур. Max. Α 2.18 2.40 0.0858 0.0945 0.0354 Α1 0.90 1.10 0.0433 A2 0.03 0.23 0.0012 0.0091 b 0.64 0.90 0.0252 0.354 b4 4.95 5.46 0.1949 0.2150 0.46 0.61 0.0181 0.0240 С c2 0.46 0.60 0.0181 0.0236 5.97 0.2350 D 6.22 0.2449 0.1949 0.2205 D1 4.95 5.60 Ε 6.35 6.73 0.2500 0.2650 4.32 0.1701 0.2165 E1 5.50 2.286 0.0900 е 0.1732 0.1850 4.40 4.70 9.35 10.40 0.3681 0.4094 Н L 1.00 1.78 0.0394 0.0701 0.0500 L2 1.27 0.0236 L4 0.60 1.02 0.0402 V2<sup>(2)</sup> -8° +8° -8° +8°

Table 5. DPAK package mechanical data

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

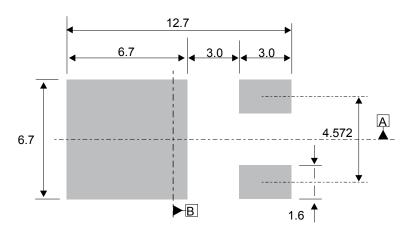


Figure 16. DPAK recommended footprint (dimensions are in mm)

The device must be positioned within ⊕0.05 AB

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<sup>1.</sup> Dimensions in inches are given for reference only

<sup>2</sup> Degree



## 2.2 IPAK package information

- Molding compouned resin is halogen free and meets UL94 flammability standard, level V0
- · Lead-free package leads plating

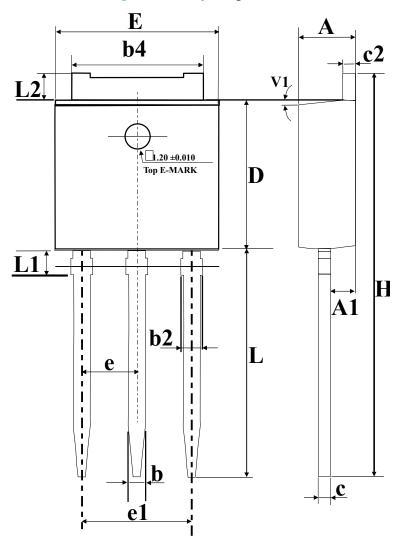


Figure 17. IPAK package outline

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Table 6. IPAK package mechanical data

	Dimensions								
Ref.	MillimetersInches (for reference only)								
	Min.	Тур.	Max.	Min.	Тур.	Max.			
А	2.20		2.40	0.086		0.094			
A1	0.90		1.10			0.035			
b	0.64		0.90	0.025		0.035			
b2			0.95			0.037			
b4	5.20		5.43						
С	0.45		0.60						
c2	0.46		0.60						
D	6		6.20						
E	6.40		6.70	0.252		0.263			
е		2.28			0.090				
e1	4.40		4.60	0.173		0.181			
Н		16.10			0.634				
L	9		9.60	0.354		0.377			
L1	0.8		1.20	0.031		0.047			
L2		0.80	1.25		0.031	0.049			
V1	10°				10°				

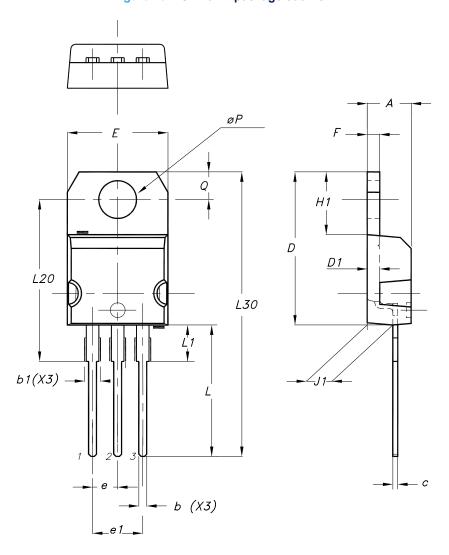
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#### 2.3 TO-220AB package information

- Molding compouned resin is halogen free and meets UL94 flammability standard, level V0
- Lead-free package leads plating
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 N·m
- Maximum torque value: 0.70 N·m

Figure 18. TO-220AB package outline



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Table 7. TO-220AB package mechanical data

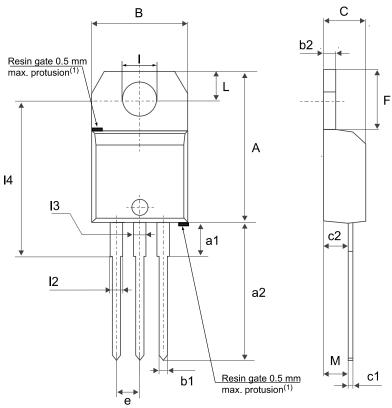
	Dimensions					
Ref.	Milli	meters	Inches (for reference only)			
	Min.	Max.	Min.	Max.		
А	4.40	4.60	0.173	0.181		
b	0.61	0.88	0.240	0.035		
b1	1.14	1.55	0.045	0.061		
С	0.48	0.70	0.019	0.028		
D	15.25	15.75	0.600	0.620		
D1	1.2	7 typ.	0.050 typ.			
Е	10.00	10.40	0.394	0.409		
е	2.40	2.70	0.094	0.106		
e1	4.95	5.15	0.195	0.203		
F	1.23	1.32	0.048	0.052		
H1	6.20	6.60	0.244	0.260		
J1	2.40	2.72	0.094	0.107		
L	13.00	14.00	0.512	0.551		
L1	3.50	3.93	0.138	0.155		
L20	16.4	10 typ.	0.646	typ.		
L30	28.9	90 typ.	1.138	typ.		
θР	3.75	3.85	0.148	0.152		
Q	2.65	2.95	0.104	0.116		



## 2.4 TO-220AB package information

- Molding compound resin is halogen free and meets UL94 flammability standard, level V0
- Lead-free plating package leads
- Recommended torque: 0.4 to 0.6 N·m

Figure 19. TO-220AB package outline



(1)Resin gate position accepted in one of the two positions or in the symmetrical opposites.

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Table 8. TO-220AB package mechanical data

			Di	mensions		
Ref.		Millimeters				
Ī	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	15.20		15.90	0.5984		0.6260
a1		3.75			0.1476	
a2	13.00		14.00	0.5118		0.5512
В	10.00		10.40	0.3937		0.4094
b1	0.61		0.88	0.0240		0.0346
b2	1.23		1.32	0.0484		0.0520
С	4.40		4.60	0.1732		0.1811
c1	0.49		0.70	0.0193		0.0276
c2	2.40		2.72	0.0945		0.1071
е	2.40		2.70	0.0945		0.1063
F	6.20		6.60	0.2441		0.2598
I	3.73		3.88	0.1469		0.1528
L	2.65		2.95	0.1043		0.1161
12	1.14		1.70	0.0449		0.0669
13	1.14		1.70	0.0449		0.0669
14	15.80	16.40	16.80	0.6220	0.6457	0.6614
М		2.6			0.1024	

<sup>1.</sup> Inch dimensions are for reference only.

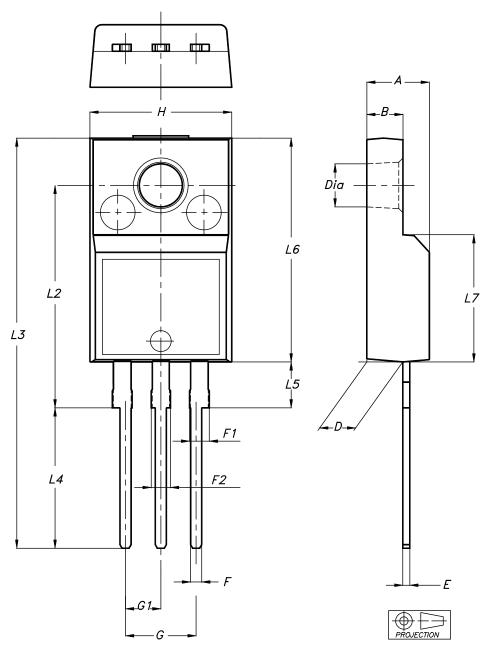
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# 2.5 TO-220FPAB package information

- Epoxy meets UL94, V0
- Recommended torque: 0.4 to 0.6 N·m

Figure 20. TO-220FPAB package outline



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Table 9. TO-220FPAB package mechanical data

		D	imensions		
Ref.	Millin	neters	Incl	Inches	
	Min.	Max.	Min.	Max.	
А	4.40	4.60	0.1739	0.1818	
В	2.5	2.7	0.0988	0.1067	
D	2.50	2.75	0.0988	0.1087	
Е	0.45	0.70	0.0178	0.0277	
F	0.75	1.0	0.0296	0.0395	
F1	1.15	1.70	0.0455	0.0672	
F2	1.15	1.70	0.0455	0.0672	
G	4.95	5.20	0.1957	0.2055	
G1	2.40	2.70	0.0949	0.1067	
Н	10.00	10.40	0.3953	0.4111	
L2	16.00	0 typ.	0.632	4 typ.	
L3	28.60	30.60	1.1304	1.2095	
L4	9.80	10.6	0.3874	0.4190	
L5	2.90	3.60	0.1146	0.1423	
L6	15.90	16.40	0.6285	0.6482	
L7	9.00	9.30	0.3557	0.3676	
Dia	3.0	3.20	0.1186	0.1265	



## 3 Ordering information

Figure 21. TN8 series

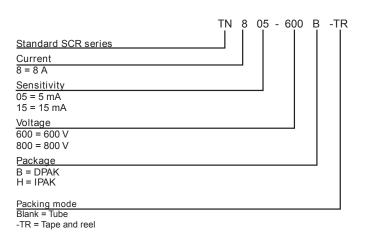


Figure 22. TS8 series

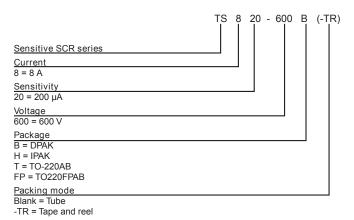
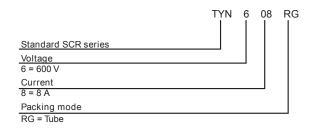


Figure 23. TYNx08 series



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Table 10. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
TN805-600B-TR	TN805600	DPAK	0.3 g	2500	Tape and reel
TN815-600B-TR	TN815600	DPAK	0.3 g	2500	Tape and reel
TN815-800B-TR	TN815800	DPAK	0.3 g	2500	Tape and reel
TN815-800H	TN815800	IPAK	0.4 g	75	Tube
TS820-600B	TS820600	DPAK	0.3 g	75	Tube
TS820-600B-TR	TS820600	DPAK	0.3 g	2500	Tape and reel
TS820-600H	TS820600	IPAK	0.4 g	75	Tube
TS820-600T	TS820600T	TO-220AB	2.3 g	50	Tube
TS820-600FP	TS820600	TO-220FPAB	2.0 g	50	Tube
TYN608RG	TYN608	TO-220AB	2.3 g	50	Tube



## **Revision history**

**Table 11. Document revision history** 

Date	Revision	Changes
Apr-2002	4A	Last update.
13-Feb-2006	5	TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added.
22-Jan-2010	6	Alpha definition updated in Figure 1. Thermal resistance, junction to case, updated in Table 5.
10-Oct-2011	7	Added TO-220FPAB package. Removed 700 V and 1000 V products.
14-May-2014	8	Updated DPAK and IPAK package information and reformatted to current standard.
03-Nov-2021	9	Added TN815-800H product information. Minor text changes.



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